A SERIES

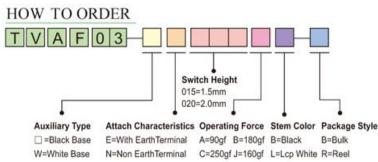






3.3x3.3 Miniature Type Tact Switch





Features

- Improve mounting density of components on PC board.
- Reflow solderable
- Contacts are completely sealed, enhancing reliability
- Available with ground terminal for electrostatic discharge
- Packaged with a 12mm wide embossed taping.

Applications

- For operating various mobile devices
- For operating various devices that require high density mounting such as mobile phones, communication devices, compact electronic devices

Specification

Items Operating temperature range		Standard	
Insulation resistance	100MW min. 100V DC		
Dielectric strength	250V AC for 1 min.		
Contact resistance	100mW max.		
Durability	Lifetime 100,000 Cycles min.		
Mechanical performance	Operating force	A:90gf B:180gf C:250gf J:160gf	
	Travel	0.20 ± 0.1mm	

Diagram

No.	Dimensions	Circuit Diagram Pad Layout
1	TVAF03 1.8 1.8 2.0 1.8 3.95±0.05 3.35±0.1	Ground terminal 2.5 5